

PATENT APPLICATION

Mail Stop Patent Application
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450



Sir:

Enclosed herewith for filing under the provisions of 37 C.F.R. §1.53(b) is the following continuation application of the prior, co-pending applications:

United States Patent Application Serial No. 08/808,246, entitled "CHAMBER FOR CONSTRUCTING A FILM ON A SEMICONDUCTOR WAFER", filed on February 28, 1997;

United States Patent Application Serial No. 08/680,913, entitled "PLASMA BOMBARDING OF THIN FILMS", filed on July 12, 1996;

United States Patent Application Serial No. 08/677,218, entitled "IN-SITU CONSTRUCTION OF AN OXIDIZED FILM ON A SEMICONDUCTOR WAFER", filed on July 9, 1996;

United States Patent Application Serial No. 08/677,185, entitled "CHAMBER FOR CONSTRUCTING AN OXIDIZED FILM ON A SEMICONDUCTOR WAFER", filed on July 9, 1996;

United States Patent Application Serial No. 08/567,461, entitled "PLASMA ANNEALING OF THIN FILMS", filed on December 5, 1995; and

United States Patent Application Serial No. 08/498,990, entitled "BIASED PLASMA ANNEALING OF THIN FILMS", filed on July 6, 1995

all of which are herein incorporated into the present continuation application by reference in its entirety.

Applicant(s): **Michal Danek**
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Yeh-Jen Kao
Dale R. DuBois
Alan F. Morrison

Title of application: CHAMBER FOR CONSTRUCTING A FILM ON A SEMICONDUCTOR WAFER

Pages of specification: 104 (4 pages of claims and 1 page abstract)

Sheets of drawing: 50

Executed on: _____

Docket No.: 761C4/CPI/L/B/PJS

	<u>No. Filed</u>	<u>Less</u>	<u>Rate/Claim</u>	<u>Fee</u>
Total Claims	22	-20	2 x \$18.00	\$ 36.00
Independent Claims	2	- 3	0 x \$86.00	\$ 0.00
			Minimum Filing Fee	\$ 770.00
			Multiple Dependency Fee (if applicable - \$280.00)	\$
			50% Reduction for Small Entity (Independent Inventor, Non-profit Corporation, or Small Business Concern) - appropriate verified statement attached	- \$ 0.00
			TOTAL	\$1,106.00
			ASSIGNMENT RECORDATION FEE	40.00
			TOTAL FILING FEE	<u>\$1,146.00</u>

Kindly charge the entire and any additional filing fee, as appropriate, to Deposit Account No. 20-0782. To facilitate that charge, a duplicate copy of this letter is enclosed herewith.

Kindly direct all correspondence to:

Patent Counsel
Applied Materials, Inc.
3050 Bowers Avenue
P.O. Box 450A
Santa Clara, CA 95052

Also enclosed herewith for filing in connection with the enclosed application are:

X A copy of the executed Declaration for prior Application Serial No. 08/808,246, which remains in effect for the subject continuation application;

X Claim(s) to priority under 35 U.S.C. §120:

<u>Serial Number</u>	<u>Filing date</u>
08/808,246	February 28, 1997
08/680,913	July 12, 1996
08/677,218	July 9, 1996

08/677,185
08/567,461
08/498.990

July 9, 1996
December 5, 1995
July 6, 1995

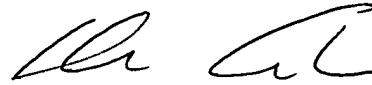
X At least prior application 08/808,246 is
co-pending.

X A copy of the executed Assignment of the prior
application 08/808,246 from the co-inventors
to Applied Materials, Inc., remains in effect for
the subject continuation application.

X 50 sheets of formal drawings.

Respectfully submitted,

Nov 18, 2003



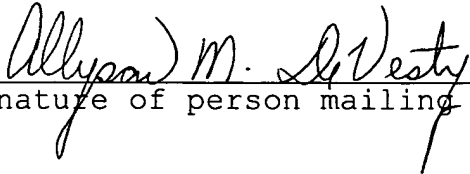
KEITH TABOADA, Attorney
Reg. No. 45,150

*****EXPRESS MAIL CERTIFICATION*****

"Express Mail" mailing label number: EV360626991US

Date of deposit: November 18, 2003

I hereby certify that this patent application and related
papers is being deposited with the United States Postal Service
"Express Mail Post Office to Addressee" service under 37 C.F.R.
1.10 on the date indicated above and is addressed to Mail Stop
Patent Application, Commissioner for Patents, P.O. Box 1450,
Alexandria, VA 22313-14150.



Signature of person mailing paper or fee

Allyson M. DeVesty

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